

WEST Search History

DATE: Thursday, December 5, 2013

<u>Set Name</u>	<u>Query</u>	<u>Hit Count</u>	<u>Set Name</u>
side by side			result set
<i>DB USPT,PGPB,JPAB,EPAB,DWPI,TDBD; PLUR YES; OP ADJ</i>			
L19	L18 and (expose or exposure)	17	L19
L18	L17 and photo near (resist or mask)	20	L18
L17	l16 and ("au" or gold or "pd" or palladium or "ag" or silver) and (au or gold) and (ni or nickel)	77	L17
L16	L15 and (acid or etch)	143	L16
L15	l2 and l3	166	L15
L14	L3 and (au or gold) and (ni or nickel)	99	L14
L13	l2 and ("au" or gold or "pd" or palladium or "ag" or silver)	189	L13
L12	L11 and (au or gold) and (ni or nickel)	20	L12
L11	l2 and (solder or soldering) near (sn or tin or ag or silver or bi or bismuth or pd or palladium) and (au or gold)	25	L11
L10	l1 and (solder or soldering) near (mask or resist or template or stencil)	153	L10
L9	L8 and (exposure or expose)	32	L9
L8	l1 and photo near (mask or resist)	41	L8
L7	l1 and ("au" or gold) and ("ni" or nickel)	132	L7
L6	l1 and ("au" or gold or "pd" or palladium or "ag" or silver)	213	L6
L5	L4 and (acid or acidic) near (etch or etching or etchant)	19	L5
L4	L3 and etch	130	L4
L3	l1 and (chemical near reduction or electroless or electroless near (plate or plating) or cement or cementation)	194	L3
L2	L1 and (sn or tin or bismuth or "bi" or pd or palladium or "ag" or silver) (solder or solderable) and dielectric and (cu or copper) near (structure or clad or layer or film or pad or trace or wiring) and (mask or resist) near (cover or covering or plate or plating)	223	L2
L1		280	L1

END OF SEARCH HISTORY